



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : **Confirmation No. 9620**
Masanobu NOGOME et al. : Docket No. 2003_1075A
Serial No. 10/630,900 : Group Art Unit 2818
Filed July 31, 2003 : Examiner Mai Huong Tran

SEMICONDUCTOR DEVICE AND
MANUFACTURING METHOD THEREOF

RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEES FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975

Sir:

Please find attached an Amendment in response to the Notice of Non-Compliant Amendment dated April 19, 2005. The attached Amendment is identical to the Amendment submitted on April 19, 2005, with the only exception being that the amended title includes markings.

Respectfully submitted,

Masanobu NOGOME et al.

By: 

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April 28, 2005



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AMENDMENT

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Sir:

Responsive to the Office Action dated March 22, 2005, please amend the
above-identified application as follows.



AMENDMENT TO THE TITLE

Please replace the original title with following rewritten title.

Semiconductor Device and Manufacturing Method Thereof Including a Photosensitive Resin Covering at Least a Portion of a Substrate Having a via Hole